

### **Features**

- Very Small Plastic Package
- High Switching Speed



#### **SOD-323**



# **Package Marking and Ordering Information**

Product ID	Pack	Marking	Qty(PCS)	
BAS316	SOD-323	A6	3000	

Maxmim Ratings (Ta=25 unless otherwise noted)

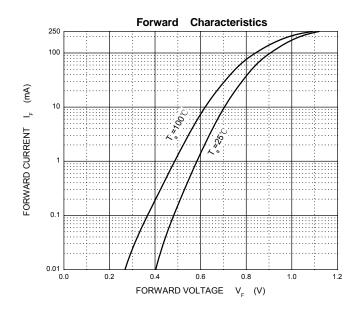
Symbol	Parameter	Value	Unit	
V <sub>RRM</sub>	Peak Repetitive Reverse Voltage	85	V	
$V_R$	DC Blocking Voltage	75		
lo	Continuous Forward Current	250	mA	
I <sub>FSM</sub>	Non-repetitive Peak Forward SurgeCurrent@t=8.3ms	2.0	А	
P <sub>D</sub>	Power Dissipation	250	mW	
$R_{\theta JA}$	Thermal Resistance from Junction to Ambient	500	°C/W	
T <sub>J</sub> ,T <sub>stg</sub>	Operation Junction and Storage Temperature Range	-55~+150	$^{\circ}$	

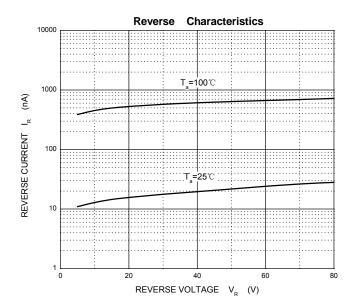
# Electrcal Charcteristics (Ta=25 unless otherwise specified)

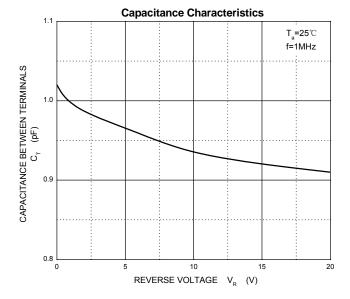
Parameter	Symbol	Test conditions	Min	Тур	Max	Unit
Reverse voltage	$V_{(BR)}$	I <sub>R</sub> =100μA	100			V
Reverse current	I <sub>R</sub>	V <sub>R</sub> =25V			30	nA
Reverse current		V <sub>R</sub> =75V			1	μΑ
Forward voltage	V <sub>F</sub>	I <sub>F</sub> =1mA			0.715	V
		I <sub>F</sub> =10mA			0.855	
		I <sub>F</sub> =50mA			1	
		I <sub>F</sub> =150mA			1.25	
Total capacitance	C <sub>tot</sub>	V <sub>R</sub> =0V,f=1MHz			1.5	pF
Reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = I <sub>R</sub> =10mA, I <sub>rr</sub> =0.1×I <sub>R</sub>			4	ns

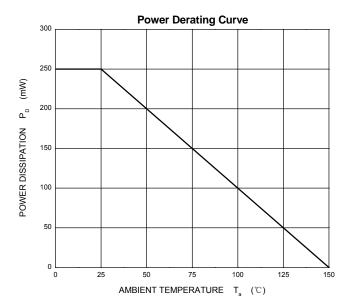


## **Typical Characteristics**



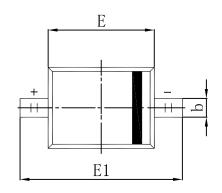


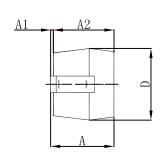


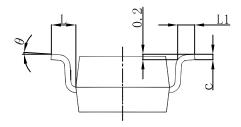




# **SOD-323 Package Outline Dimensions**

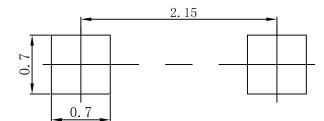






Cumbal	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α		1.100		0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.800	1.000	0.031	0.039	
b	0.250	0.350	0.010	0.014	
С	0.080	0.150	0.003	0.006	
D	1.200	1.400	0.047	0.055	
Е	1.600	1.800	0.063	0.071	
E1	2.500	2.750	0.098	0.108	
Ĺ	0.475 REF		0.019 REF		
L1	0.250	0.400	0.010	0.016	
θ	0°	8°	0°	8°	

SOD-323 Suggested Pad Layout



## Note:

- 1.Controlling dimension:in millimeters.
- 2.General tolerance:±0.05mm.3.The pad layout is for reference purposes only.



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